

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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(2,54mm) .100" **ICO SERIES** 

# **LOW PROFILE OPEN BODY DIP SOCKETS**

Mates with: APA

ICO

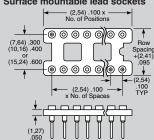
**ROW SPACING &** NO. OF CONTACTS

**STYLE** OPTION **PLATING OPTION** 

Standard Version)

#### Specify from chart below

- Low profile down to (2,11mm) .083" above printed circuit board
- · Side & end stackable
- · Open body design
- · Surface mountable lead sockets



	Row Space	Contacts
-308	.300 (7,62)	08
-314		14
-316		16
-318		18
-320		20
-322		22
-324		24
-422	.400 (10,16)	22
-624	.600 (15,24)	24
-628		28
-632		32
-640		40

GG = 30μ" (0,76μm) Gold Contact, 10μ" (0,25μm) Gold Shell GT = 30μ" (0,76μm) Gold Contact, Tin Shell

> $\mathsf{T}\mathsf{T}$ = Tin Contact and Shell (-C, -S, -ZS, -A, -L, -M, -N, only)

= 10µ" (0,25µm) Gold Contact, Tin Shell (Styles -S & -ZS only)

## = Locking Socket

Requires **Style –S**, **–ZS or –P** and (0,89mm) .035" ± (0,08mm) .003" board hole.



Requires GT Plating

#### **SPECIFICATIONS**

For complete specifications see www.samtec.com?ICO

Insulator Material: Black Glass Filled Polyester

Contact: BeCu Shell: Brass except style K Phosphor Bronze
Plating: Au or Sn over 50μ"
(1,27μm) Ni

Flammability Rating: Insulation Resistance:

5000 M $\Omega$  min Temperature Range: -55°C to +125°C with Gold -55°C to +105°C with Tin

Withstanding Voltage: 1000 VRMS @ 60 Hz Current Rating: 1A Contact Resistance:

10mΩ max Lead Size Range: (0,38mm) .015" to (0,56mm) .022" DIA and most IC leads except C, L, M, and N

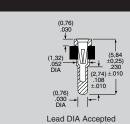
(Single Contact only) Standard = 9 oz avg, 16 oz max; Low Insertion Force = 2.5 oz avg, 5.5 oz max

Withdrawal Force: (Single Contact only) Standard = 2.5 oz avg, 1.5 oz min; Low Insertion Force = 2.0 oz avg, 0.35 oz min except **Lead-Free Solderable:** Wave only

RoHS Compliant:

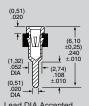
Note: Some sizes, styles and options are nonstandard, non-returnable

= Low Profile



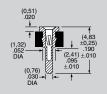
Lead DIA Accepted = (0,38mm) .015" to (0,51mm) .020"

### −M = Low Profile For LIF Specify –ZM



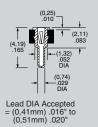
Lead DIA Accepted = (0,41mm) .016" to (0,53mm) .021"

#### $-\mathsf{N}$ = Micro Socket

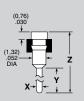


Lead DIA Accepted = (0,41mm) .016" to (0,51mm) .020"

#### = Micro Socket For LIF Specify -ZC



, **-ZS**, **-Z** Printed Circuit -ZS & -ZA= Low Insertion Force



LEAD	X	Y	Z
STYLE	DIA	TAIL	
–S or –ZS	(0,51)	(3,18)	(7,62)
	.020	.125	.300
–ZA	(0,51)	(4,57)	(8,89)
	.020	.180	.350

Locking lead (-L) available. See OPTION.

Due to technical progress, all designs, specifications and components are subject to change without notice.